

Overview

iEDX-150T Series

The iEDX-150T Series is a plating thickness measurement device ideal for product development, quality control, and process management. Recent innovations have improved precision, repeatability, and cost-effectiveness, ensuring accurate and easy measurements. Its advanced specifications distinguish it from earlier XRF models.



◎ Specification

| Model | iEDX-150T Series | | | |
|-----------------------------|--|---|---|---|
| | sp30 | mp30 | wT 30 | uT7.5, 15, 30 |
| I Major Features | | | | |
| 1 X-Ray | W Target, 50Kev 1mA, General Type Tube (X-Ray Size 400um) | W Target, 50Kev 1mA, Micro Focus Type Tube (X-Ray Size 100um) | W Target, 50Kev 1mA, Micro Focus Type Tube (X-Ray Size 100um) | W Target, 50Kev 1mA, Micro Focus Type Tube (X-Ray Size 100um) |
| 2 Detector | SDD (Silicon Drift Dector) | SDD (Silicon Drift Dector) | SDD (Silicon Drift Dector) | FSDD (Fast SDD) |
| 3 Resolution | 125eV FWHM at Mn K α | 125eV FWHM at Mn K α | 125eV FWHM at Mn K α | 123eV FWHM at Mn K α |
| 4 Collimator | 0.3mm, 0.5mm, 1mm | 0.1mm ~ 1mm | 0.1mm ~ 1mm | 7.5um, 15um, 30um |
| 5 CCD Camera | 40 (X1, X2) | 40 (X1, X2) | 40 (X1, X2) | 40 (X1, X2) |
| II Performance | | | | |
| 1 Detection Limit | 30nm | 20nm | 20nm~30nm | 5nm |
| 2 Accuracy | ±5% | ±3% | ±3% | ±1% |
| 3 Repeatability | Cov 5% ↓ | Cov 3% ↓ | Cov 3% ↓ | Cov 1% ↓ |
| III Operation System | | | | |
| 1 Computer | Samsung, HP, Lenovo | | | |
| 2 HDD | 250G | | | |
| 3 OS | Windows10 | | | |
| 4 Software | Multi-Ray 2.x.x ▶ Program Registration Number : 2009-01-199-004565 | | | |
| IV Safety | | | | |
| 1 Radiation Protection | 0.2us/h | | | |
| 2 Design Approval No. | NSSC1.30RG001.03 | | | |
| V Application | | | | |
| 1 Measurable Element | Inorganic Substances with Atomic Numbers 22 to 92 | | | |
| 2 Measurable Range (um) | Atomic No. 22-24 : 0~25, Atomic No. 25-40 : 0~35, Atomic No. 41-51 : 0~50, Atomic No. 52-82 : 0~10 | | | |
| VI Additional | | | | |
| 1 Print Format | PDF, Excel | | | |
| 2 Option | Standard Specimen ※ CoV=(Standard Deviation/Average)X100 | | | |

Model:

iEDX-150T sp30

The iEDX-150T sp30 model is an entry-level product in ISP's XRF lineup, designed for easy measurement of general and special plating. Its automated stage simplifies operation, while the streamlined analysis method allows for quick thickness assessments. This model features specifications that distinguish it from earlier XRFs.



◎ Specification

| Model | iEDX-150T sp30 |
|-----------------------------|---|
| I Major Features | |
| 1 X-Ray | W Target, 50Kev 1mA, General Type Tube (X-Ray Size 400um) |
| 2 Stage System (Stroke) | 160X160X100 mm(WDXH) ▶ 3-axis Motorized |
| 3 Detector | SDD (Silicon Drift Dector) |
| 4 Resolution | 125eV FWHM at Mn K α |
| 5 Collimator | 0.3mm, 0.5mm, 1mm (auto change) |
| 6 CCD Camera | 40 (X1, X2) |
| II Performance | |
| 1 Detection Limite | 30nm |
| 2 Accuracy | ±5% |
| 3 Repeatability | Cov 5% ↓ |
| III Operation System | |
| 1 Computer | Samsung, HP, Lenovo |
| 2 HDD | 250G |
| 3 OS | Windows10 |
| 4 Software | Multi-Ray 2.x.x ▶ Program Registration Number : 2009-01-199-004565 |
| IV Safety | |
| 1 Radiation Protection | 0.2us/h |
| 2 Design Approval No. | NSSC1.30RG001.03 |
| V Application | |
| 1 Measurable Element | ZnNi/Fe, Zn/Fe, Ni/Fe, Ni/Cu, Sn/Cu, Au/Ni/Cu |
| 2 Measurable Range (um) | Atomic No. 22-24 : 0~25, Atomic No. 25-40 : 0~35, Atomic No. 41-51 : 0~50, Atomic No. 52-82 : 0~10 |
| VI Additional | |
| 1 Print Format | PDF, Excel |
| 2 Option | Standard Specimen |

Model:

iEDX-150T mp30

The iEDX-150T mp30 model is a high-end product in ISP's XRF lineup, offering advanced plating thickness measurement. It accurately measures general plating, special plating, and ENEPIG. Its user-friendly operation, automated stage, and efficient analysis method enable quick assessments, distinguishing it from earlier XRF models.



© Specification

| Model | iEDX-150T mp30 |
|-----------------------------|---|
| I Major Features | |
| 1 X-Ray | W Target, 50KeV 1mA, Micro Focus Type Tube (X-Ray Size 100um) |
| 2 Stage System (Stroke) | 160X160X100 mm(WXDXH) ▶ 3-axis Motorized |
| 3 Detector | SDD (Silicon Drift Dector) |
| 4 Resolution | 125eV FWHM at Mn K α |
| 5 Collimator | 0.1mm ~ 1mm |
| 6 CCD Camera | 40 (X1, X2) |
| II Performance | |
| 1 Detection Limite | 20nm |
| 2 Accuracy | ±3% |
| 3 Repeatability | Cov 3% ↓ |
| III Operation System | |
| 1 Computer | Samsung, HP, Lenovo |
| 2 HDD | 250G |
| 3 OS | Windows10 |
| 4 Software | Multi-Ray 2.x.x ▶ Program Registration Number : 2009-01-199-004565 |
| IV Safety | |
| 1 Radiation Protection | 0.2us/h |
| 2 Design Approval No. | NSSC1.30RG001.03 |
| V Application | |
| 1 Measurable Element | ZnNi/Fe, Zn/Fe, Ni/Fe, Ni/Cu, Sn/Cu, Au/Ni/Cu |
| 2 Measurable Range (um) | Atomic No. 22-24 : 0~25, Atomic No. 25-40 : 0~35, Atomic No. 41-51 : 0~50, Atomic No. 52-82 : 0~10 |
| VI Additional | |
| 1 Print Format | PDF, Excel |
| 2 Option | Standard Specimen, RoHS Function can be added |

Model:

iEDX -150WT

The iEDX-150WT model is an equipment for measuring PCBs and glass in ISP's XRF lineup. It features both entry-level and high-end options, primarily for measuring gold (Au) and nickel (Ni) on copper (Cu). Its automated stage simplifies operation, while the streamlined analysis method allows for quick thickness assessments. This model features specifications that distinguish it from earlier XRFs.



◎ Specification

| Model | iEDX-150WT |
|-----------------------------|---|
| I Major Features | |
| 1 X-Ray | W Target, 50KeV 1mA, Micro Focus Type Tube (X-Ray Size 100um) |
| 2 Stage System (Stroke) | 310 X 310 X 10 mm (WXDXH), 520 X 520 X 10 mm (WXDXH) ▶ 3-axis Motorized |
| 3 Detector | SDD (Silicon Drift Dector) |
| 4 Resolution | 125eV FWHM at Mn K α |
| 5 Collimator | 0.1mm ~ 1mm |
| 6 CCD Camera | 40 (X1, X2) |
| II Performance | |
| 1 Detection Limite | 20nm |
| 2 Accuracy | ±3% |
| 3 Repeatability | Cov 3% ↓ |
| III Operation System | |
| 1 Computer | Samsung, HP, Lenovo |
| 2 HDD | 250G |
| 3 OS | Windows10 |
| 4 software | Multi-Ray 2.x.x ▶ Program Registration Number : 2009-01-199-004565 |
| IV Safety | |
| 1 Radiation Protection | 0.2us/h |
| 2 Design Approval No. | NSSC1.30RG001.03 |
| V Application | |
| 1 Measurable Element | Sn/Cu, Au/Ni/Cu, Sn/Ni/Cu, Ag/Cu |
| 2 Measurable Range (um) | Atomic No. 22-24 : 0~25, Atomic No. 25-40 : 0~35, Atomic No. 41-51 : 0~50, Atomic No. 52-82 : 0~10 |
| VI Additional | |
| 1 Print Format | PDF, Excel |
| 2 Option | Standard Specimen |

Model:

iEDX -150uT 7.5, 15, 30

The iEDX-150uT model is ISP's top-tier thickness measurement equipment, capable of measuring micro patterns at 7.5 μm , 15 μm , and 30 μm using PolyCapillary technology. With the rise of miniaturized products, our device effectively meets the increasing demand for ultra-fine pattern measurements. This model features specifications that distinguish it from earlier XRFs.



iEDX-150 μ T

© Specification

| Model | IEDX-150uT 7.5, 15, 30 | |
|-----------------------------|---|--|
| I Major Features | | |
| 1 X-Ray | W Target, 50Kev 1mA, Micro Focus Type Tube (X-Ray Size 100um) | |
| 2 Stage System (Stroke) | 160X160X100 mm(WXD _X H) ▶ 3-axis Motorized | |
| 3 Detector | FSDD (Fast Silicon Drift Detector) | |
| 4 Resolution | 123eV FWHM at Mn K α | |
| 5 Collimator | 7.5um, 15um, 30um | |
| 6 CCD Camera | 40 (X1, X2) | |
| II Performance | | |
| 1 Detection Limite | 5nm | |
| 2 Accuracy | $\pm 1\%$ | |
| 3 Repeatability | Cov 1% ↓ | |
| III Operation System | | |
| 1 Computer | Samsung, HP, Lenovo | |
| 2 HDD | 250G | |
| 3 OS | Windows10 | |
| 4 Software | Multi-Ray 2.x.x ▶ Program Registration Number : 2009-01-199-004565 | |
| IV Safety | | |
| 1 Measurable Element | 0.2us/h | |
| 2 Design Approval No. | NSSC1.30RG001.03 | |
| V Application | | |
| 1 Measurable Element | Zn, Ni, ZnNi, Au, Ag, Pd, Cu, Sn, ENIG, ENEPIG | |
| 2 Measurable Range (um) | Atomic No. 22-24 : 0~25, Atomic No. 25-40 : 0~35, Atomic No. 41-51 : 0~50, Atomic No. 52-82 : 0~10 | |
| VI Additional | | |
| 1 Print Format | PDF, Excel | |
| 2 Option | Standard Specimen | |